

# CHE260: Heat Transfer

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## Contents

1	Introduction	2
2	Electronic Cooling	2
3	Radiation	3
4	Heat Conduction	4
5	Thermal Resistance	5
6	Thermal Resistance Networks	6
7	Conduction in cylinders and spheres, Insulation	7
8	Heat Transfer from Finned Surfaces	8
9	Heat transfer from finned surfaces (contd)	9
10	Transient Heat Conduction	10
11	Transient Heat Conduction in 2 and 3 Dimensions	11
12	Transient Heat Conduction in Semi-Infinite Solids	12
13	Forced convection, Velocity and Thermal boundary layers, Reynolds, Prandtl and Nusselt numbers	14
14	Forced Convection Currents	16
15	Forced convection correlations	18
16	Thermal Radiation, Black body radiation, Radiative properties	20
17	Radiation heat transfer - black surfaces	22

# 1 Introduction

- How is heat transfer different from thermodynamics? In thermodynamics, we assume quasi-equilibrium processes i.e. the time was not an important parameter. In heat transfer, time is an important parameter and we are interested in the rate of heat transfer.
- What is the relationship between  $\dot{Q}$  and  $\Delta T$ ? What are the mechanisms of heat transfer?
- Conduction: Transfer of heat through a medium that is stationary.
- Convection: Transfer of heat from a solid surface and an adjacent fluid that is moving. Example: a fan blowing air over a hot plate. There is heat transfer from the hot plate into the fluid.
- Radiation: Energy emitted by matter in the form of electromagnetic waves.
- Radiation does not need a medium. In a vacuum, we can have radiation but not convection or conduction.
- Different mechanisms of heat transfer can take place simultaneously.
- Applications
  - Power Generation
    - \* Power plant: steam generation, condenser
    - \* Automobiles: engine cooling, space heating/cooling
  - Buildings
    - \* Heating / Cooling
    - \* Hot water
  - Refrigeration
  - Manufacturing
    - \* Casting / Heat treatment
    - \* Injection Moulding

# 2 Electronic Cooling

- > 99 % of the electrical energy supplied to a circuit is dissipated as heat
- Heat has to be dissipated to the environment while keeping the temperature of the chip in a certain range
- Heat is lost from the surface of the chip
- Important parameter is heat flux =  $\frac{\text{Heat Transfer Rate}}{\text{Unit Area}}$  (in  $\frac{W}{\text{cm}^2}$ )

- To reduce heat flux, we can reduce heat generation and increase the surface area
- As size increases, it becomes more difficult to lose heat
- Water cooling is more efficient for large systems compared to air cooling

### 3 Radiation

- Radiation is energy emitted by all matter in the form of e.m. radiation
- Thermal radiation is emitted by all bodies at a finite temperature
- Opaque objects emit only from the surface
- Amount of radiation depends on the surface temperature. Summarized by the Stefan Boltzmann Law:  $\dot{Q}_{emit} = \sigma AT_s^4$  where  $\sigma$  is the Boltzmann constant ( $5.67 \times 10^{-8} \frac{W}{m^2 K^4}$ ),  $T_s$  is the surface temperature in Kelvin and  $A$  is the surface area.
- A surface that emits as much radiation as this is called a "Blackbody". A real surface emits less than this:  $\dot{Q}_{emit} = \epsilon \sigma AT_s^4$  where  $\epsilon$  is the emissivity and  $0 \leq \epsilon \leq 1$
- Black paint has  $\epsilon = 0.99$  which is very close to 1. Aluminum foil has a low emissivity of around 0.07.
- If radiation is incident on a surface some will be absorbed. The fraction absorbed is a surface property known as the absorptivity  $\alpha$  such that  $\dot{Q}_{absorbed} = \alpha \cdot \dot{Q}_{incident}$  and  $\dot{Q}_{reflected} = (1 - \alpha) \cdot \dot{Q}_{incident}$
- Kirchoff's law says that  $\alpha = \epsilon$
- Note:  $\alpha$  and  $\epsilon$  vary over different wavelengths
- Consider a special case of radiation
  - Small surface which is completely surrounded by a much larger surface
  - $T_s$ ,  $A_s$  are temperature and area of the small surface (which is also the boundary),  $T_{surr}$  is the temperature of the surrounding surface. Both surfaces are emitting and we are interested in the net emission
  - $\dot{Q}_{rad} = \epsilon \sigma A_s (T_s^4 - T_{surr}^4)$
- Example
  - Chip with an area of  $15 \times 15 mm$ ,  $\epsilon = 0.6$ ,  $T_{surr} = 25$ .
  - Two methods of heat transfer
    - \* Natural convection
      - $h = c(T_s - T_\infty)^{\frac{1}{4}}$
      - $c = 4.2 \frac{W}{m^2 K^{\frac{5}{4}}}$

- $q_{conv} = hA(T_S - T_\infty)$
- $q_{rad} = \epsilon A(T_s^4 - T_{surr}^4)$
- \* Forced convection:  $h$  is constant at  $250 \frac{W}{m^2K}$
- $q_{conv} = hA(T_S - T_\infty)$

## 4 Heat Conduction

- Heat Conduction Equation
  - $x, y, z$  components of  $\vec{Q}$
  - $T$  is a function of  $(x, y, z, t)$
  - $\vec{Q} = \dot{Q}_x \hat{i} + \dot{Q}_y \hat{j} + \dot{Q}_z \hat{k}$
  - $\dot{Q}_x = -kA_x \frac{dT}{dx}$  (similar expressions for  $\dot{Q}_y$  and  $\dot{Q}_z$ )
- One dimensional heat conductivity can model more complicated situations. For example if  $\Delta x \ll \Delta y, z, \frac{dT}{dx} \gg \frac{dT}{dy}, \frac{dT}{dz}$  so that  $\dot{Q}_y$  and  $\dot{Q}_z$  can be neglected
- One dimensional heat conduction
  - Cross sectional area is  $A(x)$  where  $x$  is the coordinate along which heat transfer occurs
  - $\dot{Q}_x$  at the entry and  $\dot{Q}_{x+\Delta x}$  at the exit
  - Want to find  $T(x)$  inside the object
  - Rate of increase of enthalpy  $= mc_p \frac{\partial T}{\partial t} = \rho V c_p \frac{\partial T}{\partial t} = \rho c_p A \Delta x \frac{\partial T}{\partial t}$
  - Energy balance:
    - \*  $\rho c_p A \Delta x \frac{\partial T}{\partial t} = \dot{Q}_x - \dot{Q}_{x+\Delta x}$
    - \* After simplifying and taking the limit as  $\Delta x$  approaches 0, we get  $\rho c_p \frac{\partial T}{\partial t} = \frac{-1}{A} \frac{\partial(\dot{Q}A)}{\partial x}$
    - \*  $A$  depends on the coordinate system and we use Fourier's law for  $\dot{Q}$ :  $\dot{Q} = -k \frac{dT}{dx}$
- Cartesian Coordinates
  - $A$  is a constant
  - $\rho c_p \frac{\partial T}{\partial t} = \frac{\partial}{\partial x} [k \frac{\partial T}{\partial x}]$
  - Assume  $k$  is constant. Then  $\frac{\partial T}{\partial t} = \alpha \frac{\partial^2 T}{\partial x^2}$  where  $\alpha = \frac{k}{\rho c_p}$ .
  - If steady state i.e.  $\frac{\partial T}{\partial t} = 0$  then  $\frac{d^2 T}{dx^2} = 0$ .
  - Units of  $\alpha = \frac{k}{\rho c_p}$ , the thermal diffusivity is  $\frac{m^2}{s}$ .
  - High  $k$  means the material conducts well. High  $\rho c_p$  means that the material stores energy
- Cylindrical Coordinates

- Heat being conducted radially so  $\dot{q} = -k \frac{\partial T}{\partial r}$  and  $A = 2\pi r L$
- $p c_p \frac{\partial T}{\partial t} = \frac{-1}{2\pi r L} [\frac{\partial}{\partial r} \cdot \frac{\partial T}{\partial r}]$
- $\frac{1}{\alpha} \frac{\partial T}{\partial t} = \frac{1}{r} \frac{\partial}{\partial r} (r \cdot \frac{\partial T}{\partial r})$
- At steady state,  $\frac{d}{dr} (r \frac{dT}{dr}) = 0$ .
- Spherical Coordinates
  - $A = 4\pi r^2$  and  $\dot{q} = -k \frac{\partial T}{\partial r}$  where  $r$  is the radial spherical coordinate
  - $\frac{1}{\alpha} \frac{\partial T}{\partial t} = \frac{1}{r^2} \frac{\partial}{\partial r} (r^2 \frac{\partial T}{\partial r})$
- In general  $\frac{1}{r^n} \frac{\partial}{\partial r} (r^n \frac{\partial T}{\partial r}) = \frac{1}{\alpha} \frac{\partial T}{\partial t}$  where cartesian has  $n = 0$ , cylindrical has  $n = 1$  and spherical has  $n = 2$ .

## 5 Thermal Resistance

- At steady state,  $\frac{d^2 T}{dx^2} = 0$
- Heat flux:  $\dot{q} = -k \frac{dT}{dx}$ .
- Heat flux is a constant
- Heat transfer rate:  $\dot{Q} = \dot{q} A = \frac{-k A (T_2 - T_1)}{L}$
- $\dot{Q} = \frac{T_1 - T_2}{R_{wall}}$  where  $T_1$  and  $T_2$  are the temperatures of the walls
- $R_{cond} = R_{wall} = \frac{L}{kA}$
- Similar to current with voltage and Resistance
- $\dot{Q}_{conv} = hA(T_s - T_\infty)$
- $R_{conv} = \frac{T_s - T_\infty}{\dot{Q}_{conv}} = \frac{1}{hA}$
- Radiation is more complicated.  $\dot{Q}_{rad} = \epsilon \sigma A (T_s^4 - T_{sur}^4)$
- We need to define a heat transfer coefficient for radiation.  $h_{rad} = \frac{\epsilon \sigma A (T_s^4 - T_{sur}^4)}{A(T_s - T_{sur})}$
- $h_{rad} = \epsilon \sigma (T_s^2 + T_{sur}^2)(T_s + T_{sur})$
- Can treat it as a resistance.  $R_{rad} = \frac{T_s - T_{sur}}{\dot{Q}_{rad}} = \frac{1}{h_{rad} A}$
- Multilayer Plane Wall
  - Each layer has the same surface Area
  - Layers have thicknesses  $L_i$
  - Temperature varies as  $T_1$  on the outside,  $T_2, \dots, T_{n+1}$  where  $n$  is the number of surfaces

- Treat each layer separately as resistances in series
- For first wall  $\dot{Q} = \frac{T_1 - T_2}{R_1}$  so  $T_1 - T_2 = \dot{Q}R_1$ . In general,  $T_i - T_{i+1} = \dot{Q}R_i$
- Summing all of them gives  $T_1 - T_{n+1} = \dot{Q}(R_1 + \dots + R_n)$  so that  $\dot{Q} = \frac{T_1 - T_4}{R_{total}}$
- Therefore you can sum up resistances similar to electric circuits
- We can find each  $R_i$  as  $\frac{L_i}{k_i A}$
- $\dot{Q} = UA(T_{\infty,1} - T_{\infty,4})$  where  $U$  is the overall heat transfer
- Example: Refrigerator Wall
  - 1 mm thick insulation on the outside and width of refrigerator is  $L$ .
  - $T_{room} = 25^\circ C$  and  $T_{refrig} = 3^\circ C$
  - $h_0 = 9 \frac{W}{m^2 C}$  and  $h_i = 4 \frac{W}{m^2 C}$
  - $k_{steel} = 15.1 \frac{W}{m^2 C}$  and  $k = 0.035 \frac{W}{m^2 C}$  inside the refrigerator
  - Constraint is that  $T_{s,out} > 20$ . We assume heat transfer from the outside room to the inside of the refrigerator
  - What is  $L$  to ensure  $T_{s,out} > 20$  to prevent condensation on the outside of the refrigerator
  - Thermal circuit consists of a convective resistance outside the refrigerator followed by 3 conductive resistance on the surfaces and then one convective resistance at the end
  - INSERT PICTURE FROM LEC NOTES
  - $\dot{Q} = \frac{T_{room} - T_{s,out}}{R_{conv,0}} = \frac{T_{room} - T_{s,out}}{\frac{1}{h_0 A}}$
  - Consider unit area. Then  $\dot{Q} = h_0(T_{room} - T_{s,out}) = 9(25 - 20) = 45W$
  - $R_{total} = \frac{1}{h} + (\frac{L}{k})_{metal} + (\frac{L}{k})_{insulation} + (\frac{L}{k})_{metal} + \frac{1}{h_i} = \frac{1}{9} + \frac{10^{-3}}{15.1} + \frac{L_2}{0.035} + \frac{10^{-3}}{15.1} + \frac{1}{4} = 0.361 + \frac{L_2}{0.035}$
  - $\dot{Q} = \frac{T_{room} - T_{refrig}}{R_{total}} \rightarrow 45(0.361 + \frac{L_2}{0.035}) = 25 - 3$  so that  $L = 45mm$

## 6 Thermal Resistance Networks

- Multiple layers e.g. in an electric chip each with different thermal properties
  - We are interested in  $\dot{Q} = \dot{Q}_1 + \dot{Q}_2 + \dot{Q}_3 = \frac{T_1 - T_2}{R_1} + \frac{T_1 - T_2}{R_2} + \frac{T_1 - T_2}{R_3}$
  - $= (T_1 - T_2)(\frac{1}{R_1} + \frac{1}{R_2} + \frac{1}{R_3}) = \frac{T_1 - T_2}{R_{total}}$
  - This is the electrical analog to parallel resistances
- Thermal contact resistance
  - So far we have been assuming perfect contact between different boundaries

- In reality, there is a rough surface at the boundary
- We can always define a thermal contact resistance  $R_c = \frac{T_2 - T_1}{\dot{q}}$  (units are  $\frac{m^2 C}{W}$ )  
(Note: Resistance per unit area)
- The reciprocal of  $R_c$  is known as the thermal contact conductance  $h_c$ .
- $h = \frac{1}{R_c} = \frac{\dot{q}}{\Delta T}$  so that  $\dot{q} = h_c \Delta T$
- $h_c$  is thus similar to the heat transfer coefficient
- Heat conduction in cylinders & spheres
  - INSERT DRAWING FROM THE SLIDES
  - For a long pipe, the main temperature gradient is in the radial direction i.e.  $\frac{dT}{dx} \ll \frac{dT}{dr}$
  - Therefore we can assume 1-D radial conduction
  - INSERT  $r_1, r_2$  diagram
  - Solve heat conduction equation in cylindrical coordinates to get  $T(r)$
  - Steady state:  $\frac{d}{dr}(r \frac{dT}{dr}) = 0$ , at  $r = r_1, T = T_1$  and at  $r = r_2, T = T_2$
  - Integrate this to get  $T(r) = c_1 \ln r + c_2$
  - Using the boundary conditions gives  $c_1 = \frac{T_1 - T_2}{\ln(\frac{r_1}{r_2})}$  and  $c_2 = T_2 - \frac{T_1 - T_2}{\ln(\frac{r_1}{r_2})} \ln r_2$
- Define thermal resistance of a cylinder
  - $R_{cyl} = \frac{T_1 - T_2}{\dot{Q}_{cond}} = \frac{\ln(\frac{r_2}{r_1})}{2\pi L K}$

## 7 Conduction in cylinders and spheres, Insulation

- Inner temperature and then two surface layers
- $R_C = \frac{1}{hA} = \frac{1}{2\pi r L h}$
- $R_{total} = R_{c,1} + R_{cond} + R_{c,2} = \frac{1}{2\pi r_1 L h_1} + \frac{\ln(\frac{r_2}{r_1})}{2\pi L K} + \frac{1}{2\pi r_2 L h_2}$
- Insulation
  - $R_{total} = R_{c,1} + R_{cyl,1} + R_{cyl,2} + R_{c,2}$  where  $R_{cyl,2}$  is for the insulation
  - For a sphere
    - \* Insulation around a spherical metal tank
    - \*  $R_{total} = R_{c,1} + R_{sph,1} + R_{sph,2} + R_{c,2}$
    - \*  $= \frac{1}{4\pi r_1^2 h_1} + \frac{r_2 - r_1}{4\pi r_1 r_2 k_1} + \frac{r_3 - r_2}{4\pi r_2 r_3 k_2} + \frac{1}{4\pi r_3^2 h_2}$
- R-value
  - Thermal resistance. Thickness  $L$ , Surface area  $A$  and thermal conductivity  $k$

- $R = \frac{L}{k}$  is the R-value
- $\dot{Q} = \frac{\Delta T}{R} \times A$
- Units here are in imperial units i.e.  $L$  is in feet,  $k$  is in  $\frac{Btu}{hftF}$
- Critical Radius of insulation
  - Consider the area for heat loss
  - Insulation: increase thickness, increasing conduction resistance and decreasing convective resistance
  - Can we increase heat transfer?
    - \* Plot  $\dot{Q}$  against  $r_2$  to find the critical value of Resistance
    - \* Equivalently set  $\frac{d\dot{Q}}{dr_2} = 0$  to find the critical radius

## 8 Heat Transfer from Finned Surfaces

- Read Chapter 17.6
- How to find  $R_{heatsink}$  for finned surfaces e.g. heat sinks in computers
- Add diagram from notes: We have a cylinder with cross sectional area  $A_c(x)$  and heat transfer coeff  $h$ .
  - Consider a thin slice of this with thickness  $\Delta x$  some distance  $x$  away from the end
  - Energy balance  $\dot{Q}_{cond,x}$  in and  $\dot{Q}_{cond,x+\Delta x}$  out
  - Energy in = Energy out:  $\dot{Q}_{cond,x} = \dot{Q}_{cond,x+\Delta x} + \dot{Q}_{conv}$
  - Let the perimeter of fin be  $P$ . Then surface area of element is  $P\Delta x$  so that  $\dot{Q}_{conv} = hP\Delta x(T - T_\infty)$
  - Simplifying the energy balance by taking the limit as  $\Delta x \rightarrow 0$ :  $\frac{d\dot{Q}_{cond}}{dx} + hP(T - T_\infty) = 0$
  - Using Fourier's law  $\dot{Q}_{cond} = -kA_C \frac{dT}{dx}$ :  $\frac{d}{dx}(kA_c \frac{dT}{dx}) - hP(T - T_\infty) = 0$
  - Assuming  $A_C, k, P$  constant:  $\frac{d^2T}{dx^2} - \frac{hP}{kA_C}(T - T_\infty) = 0$
  - Define  $\Theta = T - T_\infty$  and  $a^2 = \frac{hP}{kA_C}$  (constant) so that  $\frac{d^2\Theta}{dx^2} - a^2\Theta = 0$  where the solution is  $\Theta(x) = c_1e^{ax} + c_2e^{-ax}$
  - Boundary conditions:  $T = T_b$  at the left end while on the right end as  $L \rightarrow \infty$ ,  $T = T_\infty$
  - Therefore we simplify by having  $T = T_\infty$  at  $x = L$
  - In terms of  $\Theta$ : At  $x = 0$ ,  $\Theta = T_b - T_\infty = \Theta_b$  and  $\Theta(\infty) = 0$
  - This gives  $c_1 = 0$  and  $c_2 = \Theta_b$  so that the solution is  $\Theta(x) = \Theta_b e^{-ax}$



- What is the heat loss from the fin?  $\dot{Q}_b = -kA_c \frac{dT}{dx}|_{x=0} \dot{Q}_{fin}$
- $\dot{Q}_{fin,long} = \sqrt{hPkA_c}(T_b - T_\infty)$
- Finite fin length: What is the boundary condition at the open end
  - We can heat transfer is negligible so that adiabatic and  $\frac{dT}{dx} = 0$  at the boundary
  - At  $x = L$ ,  $\frac{dT}{dx} = 0$  so that  $\frac{d\Theta}{dx} = 0$ :  $c_1 e^{aL} - c_2 e^{-aL} = 0$
  - At  $x = 0$ ,  $\Theta = \Theta_b$
  - Solve for  $c_1$  &  $c_2$  and the following solution will be obtained:  $\frac{T(x)-T_\infty}{T_b-T_\infty} = \frac{\cosh a(L-x)}{\cosh aL}$
- Can do the same for  $\dot{Q}_{fin,insulated} = -kA_c \frac{dT}{dx}|_{x=0}$  which will give  $\dot{Q}_{fin,insulated} = \sqrt{hPkA_c}(T_b - T_\infty) \tanh(aL)$  where  $a = \sqrt{\frac{hP}{kA_c}}$
- To account for heat transfer from the tip, we can add a length  $\Delta L$  at the end and the area there will be  $A_c = \Delta LP$  ( $P$  is the perimeter of the fin) so that the corrected length is  $L_c = L + \frac{A_c}{P}$

## 9 Heat transfer from finned surfaces (contd)

- Fin efficiency
  - $\Delta T$  given by the difference between the fin temperature and the surrounding
  - Most efficient fin would have a uniform temperature  $T_b$  everywhere
  - This would imply an infinite thermal conductivity
  - In this case,  $\dot{Q} = hA_{fin}(T_b - T_\infty) = hPL(T_b - T_\infty)$
  - We define  $\eta_{fin} = \frac{\dot{Q}_{fin}}{\dot{Q}_{fin,max}}$
  - For an infinitely long fin,  $\eta_{fin,long} = \frac{\sqrt{hPkA_c}(T_b-T_\infty)}{hPL(T_b-T_\infty)} = \frac{1}{L} \sqrt{\frac{kA_c}{hP}} = \frac{1}{aL}$  which is in terms of physical properties
  - $\dot{Q}_{fin} = \eta_{fin} \dot{Q}_{fin,max} = \eta_{fin} hA_{fin}(T_b - T_\infty) = h\eta_{fin} A_{fin}(T_b - T_\infty)$
  - $\eta_{fin} A_{fin}$  can be treated as the corrected area
  - For an insulated tip, perform the same steps with the original definition to get  $\eta_{insulatedtip} = \frac{\tanh aL}{aL}$
- Fin effectiveness
  - How much has the fin increased heat transfer by?
  - $\epsilon_{fin} = \frac{\dot{Q}_{fin}}{\dot{Q}_{nofin}}$
  - $\dot{Q}_{nofin} = hA_c(T_b - T_\infty)$
  - $\dot{Q}_{longfin} = \sqrt{hPkA_c}(T_b - T_\infty)$  so that  $\epsilon_{longfin} = \sqrt{\frac{kP}{hA_c}}$

- To increase the effectiveness, make  $k$  as large as possible and maximize  $\frac{P}{A_c}$
- Fins are most effective with low  $h$  so they are used for gases, hot liquids
- Generally we use fins if  $\epsilon \geq 2$
- When can we assume fins are infinitely long?
  - $\frac{\dot{Q}_{fin,insulated}}{\dot{Q}_{fin,long}} = \tanh(aL)$ .  $\tanh$  asymptotically approaches 1 as  $aL$  approaches  $\infty$
  - In practice, if  $aL \geq 5$  we can assume an infinitely long fin. But even  $aL = 1$  has  $\tanh = 0.76$  so it gives 76 % of heat transfer of an infinitely long fin. Therefore  $L = \frac{1}{a}$  is a reasonable length for a fin
- Designing a heat sink
  - $\dot{Q}_{total} = \dot{Q}_{unfanned} + \dot{Q}_{fin}$
  - From the definition of efficiency  $\dot{Q}_{fin} = \eta_{fin} \cdot hA_{fin}(T_b - T_\infty)$
  - $\Rightarrow \dot{Q}_{total} = hA_{unfanned}(T_b - T_\infty) + h\eta_{fin}A_{fin}(T_b - T_\infty) = h[A_{unfanned} + \eta_{fin}A_{fin}](T_b - T_\infty)$
  - We can define a thermal resistance  $R_{fin} = \frac{T_b - T_\infty}{\dot{Q}_{total}} = \frac{1}{h[A_{unfanned} + \eta_{fin}A_{fin}]}$

## 10 Transient Heat Conduction

- Consider a solid at temperature  $T_i$  and a liquid at  $T_\infty < T_i$ . The solid is dropped into the liquid. How does  $T$  vary over time?
  - We would expect the temperature  $T$  to asymptotically approach  $T_\infty$
  - Heat Conduction equation:  $\frac{\partial^2 T}{\partial x^2} + \frac{\partial^2 T}{\partial y^2} + \frac{\partial^2 T}{\partial z^2} = \frac{1}{\alpha} \frac{\partial T}{\partial t}$
  - We set the first three terms equal to 0 by using the lumped capacitance approximation i.e. no temperature gradient in the body
  - We would expect this to be valid when the object is small and has a high thermal conductivity
  - Using an energy balance:  $\dot{E}_{store} = -\dot{Q}_{conv}$
  - $\dot{E}_{store} = mc_p \frac{dT}{dt} = \rho V c_p \frac{dT}{dt}$  and  $\dot{Q}_{conv} = hA(T - T_\infty)$
  - Equating the two, we get  $\frac{d(T - T_\infty)}{T - T_\infty} = -\frac{hA}{\rho V c_p} dt$  so that  $\ln(T - T_\infty) = \frac{-hA}{\rho V c_p} t + C_1$
  - Using  $T = T_i$  at  $t = 0$ , we get  $\ln \left[ \frac{T - T_\infty}{T_i - T_\infty} \right] = \frac{-hA}{\rho V c_p} t$
  - We define a "time constant"  $\tau = \frac{\rho V c_p}{hA}$  so that  $\frac{T - T_\infty}{T_i - T_\infty} = \exp \left[ \frac{-t}{\tau} \right]$
  - The LHS starts at 1 and decays to 0 as  $t \rightarrow \infty$ . Moreover at  $t = \tau$ , the value is  $\frac{1}{e} \approx 0.368$
- The response time of a thermometer is usually  $3\tau$ . However it is important to note that  $\tau$  is a function of  $h$  so it varies in different environments

- Moreover  $\tau$  depends on  $\frac{V}{A} = \frac{r}{3}$  for a sphere so to get a fast response time you would make it very thin
- When is a lumped capacitance valid?
  - At steady state, the conduction in a solid must be equal to the convection in a fluid i.e.  $kA\frac{(T_1-T_2)}{L} = hA(T_2 - T_\infty)$  i.e.  $\frac{T_1-T_2}{T_2-T_\infty} = \frac{hL}{k}$
  - $\frac{hL}{k}$  is a dimensionless number and is known as a Biot number.
  - Note:  $k$  is the thermal conductivity of the solid,  $L$  is the length scale in the direction of conduction
  - Suppose the Biot number is large i.e.  $\gg 1$  so that  $T_1 - T_2 \gg T_2 - T_\infty$
  - If Biot number is very small, then  $T_1 - T_2 \ll T_2 - T_\infty$  so we can neglect  $T$  change inside the body (we assume uniform temp in the body) and use the lumped capacitance model
  - By  $\ll$  we typically mean a Biot value  $< 0.1$
  - In an irregular body, the length scale used is  $L = \frac{V}{A}$

## 11 Transient Heat Conduction in 2 and 3 Dimensions

- A ball of volume  $V$ , mass  $m$  and SA  $A$  and heat transfer coefficient  $h$  is dropped into a fluid
- Assume that the temperature  $T$  is uniform in the body
- We had previously assumed that if  $Bi < 0.1$  we have a lumped capacitance
- Example: Steel shaft,  $k = 51.2$ ,  $\rho = 7832$ ,  $c = 541$  and  $T_i = 300$  is placed into a furnace with  $T_\infty = 1200$ .
  - How long before the shaft temperature reaches 800?
  - We first calculate the Biot number as  $Bi = \frac{hL}{k}$  where  $L = \frac{V}{A} = \frac{\pi r^2 L}{2\pi r L} = \frac{r}{2}$
  - Then  $Bi = \frac{h\frac{r}{2}}{k} = \frac{100 \times \frac{0.05}{2}}{51.2} = 0.05$  so we can apply the lumped value
  - $\frac{T-T_\infty}{T_i-T_\infty} = \exp\left[-\frac{hA}{\rho V c} t\right]$  where  $\frac{A}{V} = \frac{2}{r}$
  - This gives  $\ln\left[\frac{800-1200}{300-1200}\right] = \dots$  and solving gives  $t = 859s$
- Transient heat conduction in 3 dimensions e.g. plane walls, cylinders, spheres
  - What happens if  $Bi > 0.1$ ?
  - In this case we cannot neglect the temperature gradients inside the body
  - Have to solve the complete heat conduction equation
  - Consider a solid wall with temperature  $T_i$  on one side which then instantly becomes lowered to a temperature  $T_\infty$  as it is placed into a fluid.

- As time increases, the temperature inside the wall e.g. at the center decreases
- So in this case,  $T$  is a function of  $x$  and  $t$
- For a plane wall  $\frac{\partial^2 T}{\partial x^2} = \frac{1}{\alpha} \frac{\partial T}{\partial t}$  where  $\alpha = \frac{k}{\rho c_p}$  is the thermal diffusivity
- Second order wrt  $x$  so two boundary conditions are needed there. First order wrt  $t$  so one initial condition is needed there
- This can be solved analytically but we will not do that
- We instead consider the lumped capacitance solution  $\ln \left[ \frac{T - T_\infty}{T_i - T_\infty} \right] = \frac{-hA}{\rho V c_p} t$
- We take the characteristic length  $L = \frac{V}{A}$ .
- $\frac{hA}{\rho V c_p} t = \frac{h}{\rho L c_p} t = \left( \frac{h}{\rho L c_p} t \right) \left( \frac{L}{L} \cdot \frac{k}{k} \right) = \left( \frac{hL}{k} \right) \left( \frac{k}{\rho c_p} \right) \left( \frac{t}{L^2} \right) = \left( \frac{hL}{k} \right) \left( \frac{\alpha t}{L^2} \right)$  where  $Bi = \frac{hL}{k}$  which is unitless
- We define the Fourier number  $Fo = \frac{\alpha t}{L^2}$  which is also dimensionless
- The dimensionless temperature  $\Theta = \frac{T - T_\infty}{T_i - T_\infty}$  so that the lumped capacitance solution can be written as  $\Theta = \exp(-Bi \cdot Fo)$
- A physical interpretation of the Fourier number can be found by considering a cube with side length  $L$ . Then  $\dot{Q}_{cond} = kA \frac{\partial T}{\partial x} = kL^2 \frac{\Delta T}{L} = kL \Delta T$
- $\dot{Q}_{store} = mc_p \frac{\partial T}{\partial t} = \rho L^3 c_p \frac{\Delta T}{t}$  so that  $\frac{\dot{Q}_{cond}}{\dot{Q}_{store}} = \frac{k}{\rho c_p} \cdot \frac{t}{L^2} = \frac{\alpha t}{L^2} = Fo$
- Even when we cannot assume lumped capacitance and get an exact solution of the heat conduction equation, the solution is of the form  $\Theta = \Theta(Bi, Fo)$
- We can define  $\Theta_0 = \frac{T_0 - T_\infty}{T_i - T_\infty}$  so that the solution is of the form  $\Theta_0 = A_1 e^{-\lambda_1^2 Fo}$  where  $A_1, \lambda_1$  are function of  $Bi$
- Example: Carbon steel plate with  $T_i = 440$  is placed in a furnace at  $T_\infty = 600$ . We need to heat to a minimum temperature of 520. What is the time  $t$  required.
  - $h = 200, k = 40$  and  $\alpha = 8 \times 10^{-6}$
  - $Bi = \frac{hL}{k} = \frac{200 \times 0.04}{40} = 0.2$
  - Since  $Bi > 0.1$ , we cannot use the lumped capacitance and instead use the analytical solution which we obtain from tables
  - From Table 18.2,  $Bi = 0.2 \implies \lambda_1 = 0.4328, A_1 = 1.0311$
  - $\Theta_0 = \frac{T_0 - T_\infty}{T_i - T_\infty} = A_1 e^{-\lambda_1^2 Fo}$
  - $\Theta_0 = \frac{520 - 600}{440 - 600} = 0.5$  so that  $0.5 = 1.0311 \exp(-(0.4328)^2 Fo)$  and so  $Fo = 3.864$
  - $Fo = \frac{\alpha t}{L^2} \implies t = \frac{Fo L^2}{\alpha} = \frac{3.864 \times (0.04)^2}{8 \times 10^{-6}} = 773s$

## 12 Transient Heat Conduction in Semi-Infinite Solids

- The general problem consists of a body at temperature  $T_i$  with the surface temperature suddenly being changed to  $T_s$ .

- Temperature variation would go from  $T_s$  down to  $T_i$ .  $\delta$  corresponds to a skin depth and after that we are in the core
- How does the skin depth  $\delta$  vary with time?
- Heat conduction equation with one dimension:  $\frac{\partial^2 T}{\partial x^2} = \frac{1}{\alpha} \frac{\partial T}{\partial t}$
- An estimate of  $\frac{\partial^2 T}{\partial x^2}$  can be found as  $\frac{(\frac{\partial T}{\partial x})_{x \sim \delta} - (\frac{\partial T}{\partial x})_{x \sim 0}}{\delta}$
- $(\frac{\partial T}{\partial x})_{x=0} \sim \frac{T_i - T_s}{\delta}$  so that  $\frac{\partial^2 T}{\partial x^2} \sim 0 - \frac{T_i - T_s}{\delta^2}$ ,  $\frac{\partial T}{\partial t} \sim \frac{T_s - T_i}{t}$
- From the heat conduction equation  $-\frac{T_i - T_s}{\delta^2} \sim \frac{1}{\alpha} \frac{T_s - T_i}{t}$
- Time for effect to be felt throughout the body is  $t_c \sim \frac{r_0^2}{\alpha}$
- $\delta \sim \sqrt{\alpha t}$
- For a short time  $t \ll t_c$ , we can treat the body as being semi infinite
- The exact solution is given by  $\frac{\partial^2 T}{\partial x^2} = \frac{1}{\alpha} \frac{\partial T}{\partial t}$
- $\delta$  grows as a function of time
- Boundary conditions: At  $x = 0$ ,  $T(0, t) = T_s$  and as  $x \rightarrow \infty$ ,  $T(\infty, t) = T_i$
- Initial conditions:  $T(x, 0) = T_i$
- Define a similarity variable  $\eta = \frac{x}{\delta}$  such that  $0 < \eta < 1$
- $\eta = \frac{x}{2\sqrt{\alpha t}}$  so that  $\frac{\partial T}{\partial t} = \frac{dT}{d\eta} \cdot \frac{\partial \eta}{\partial t} = \frac{d}{dt} \left[ \frac{-x}{4t\sqrt{\alpha t}} \right]$
- $\frac{\partial T}{\partial x} = \frac{dT}{d\eta} \cdot \frac{\partial \eta}{\partial x} = \frac{dT}{d\eta} \left[ \frac{1}{2\sqrt{\alpha t}} \right]$
- $\frac{\partial^2 T}{\partial x^2} = \frac{d}{d\eta} \left( \frac{\partial T}{\partial \eta} \right) \cdot \frac{\partial \eta}{\partial x} = \frac{d^2 T}{d\eta^2} = \frac{1}{4\alpha t}$
- Transforming the heat conduction equation, we get  $\frac{d^2 T}{d\eta^2} = \frac{1}{\alpha} \frac{dT}{d\eta} \left( \frac{-x}{4t\sqrt{\alpha t}} \right) = -2\eta \frac{dT}{d\eta}$
- The PDE is now an ODE
- At  $x = 0$ ,  $\eta = 0$ ,  $T(0) = T_s$  and as  $x \rightarrow \infty$ ,  $\eta \rightarrow \infty$ ,  $T(\infty) = T_i$
- Let  $w = \frac{dT}{d\eta}$  so that  $\frac{dw}{d\eta} = -2\eta w$  which gives  $\ln w = -\eta^2 + c_0$
- $\frac{dT}{d\eta} = w = c_0 e^{-\eta^2}$  and integrating,  $T = c_0 \int_0^\eta e^{-u^2} du + c_1$
- Boundary conditions give  $T_i = c_0 \int_0^\infty e^{-u^2} du + T_s$  which gives the solution  $\frac{T - T_s}{T_i - T_s} = \frac{2}{\sqrt{\pi}} \int_0^\eta e^{-u^2} du = \text{erf}(\eta)$  where the RHS is the error function
- Can also be written as  $1 - \frac{T - T_s}{T_i - T_s} = 1 - \text{erf}(\eta)$  or  $\frac{T - T_i}{T_s - T_i} = \text{erfc}(\eta)$

- Heat Flux at Surface

- $\dot{q}_s = -k \frac{\partial T}{\partial x} \Big|_{x=0} = 0k \frac{\partial T}{\partial \eta} \frac{\partial \eta}{\partial x} \Big|_{\eta=0}$
- $\frac{d\eta}{dx} = \frac{1}{2\sqrt{\alpha t}}$
- $\dot{q} = \frac{k(T_s - T_i)}{\sqrt{\pi \alpha t}}$

- Contact of two semi-infinite bodies

- One body with temperature  $T_{A,i}$  and conductivity  $k_A$  and the other with  $T_{B,i}$  and  $k_B$
- We require that  $T_{S,A} = T_{S,B}$
- The heat flux must be the same i.e.  $\dot{q}_{S,A} = \dot{q}_{S,B}$
- $$-\frac{k_A(T_s - T_{A,i})}{\sqrt{\pi(\alpha_A t)}} = \frac{k_B(T_s - T_{B,i})}{\sqrt{\pi(\alpha_B t)}}$$
- $$\implies \frac{T_{A,i} - T_s}{T_s - T_{B,i}} = \frac{\sqrt{(k\rho c)_B}}{\sqrt{(k\rho c)_A}}$$
- Define effusivity as  $\gamma = \sqrt{k\rho c}$

## 13 Forced convection, Velocity and Thermal boundary layers, Reynolds, Prandtl and Nusselt numbers

### • Forced Convection

- Convection is the heat transfer from a surface to a moving fluid
- Forced part means that motion is imposed by external means
- A surface at a temperature  $T_s$  and a fluid with velocity  $V_\infty$  and temperature  $T_\infty$
- $\dot{Q}_{conv} = hA(T_s - T_\infty)$
- How do we determine  $h$ ?
  - \* Quite complicated
  - \* Depends on physical properties of fluid: viscosity  $\mu$ , density  $\rho$ , thermal conductivity  $k$  and specific heat  $c_p$
  - \* Depends on the fluid velocity  $V_\infty$
  - \* Depends on the shape and size of body: Characteristic length i.e. for a plate it is the length  $L$  whereas for a cylinder or sphere it is the diameter  $D$ . Differences for objects of irregular shapes
  - \* Type of flow - laminar, turbulent

### • Velocity Boundary layer

- Incoming flow at velocity  $V_\infty$  and temperature  $T_\infty$  and a solid plate
- There is a no slip condition at the interface between the fluid and the solid. i.e. the velocity at the interface must be 0 but if you move away, it will go back to  $V_\infty$
- We can define a boundary layer thickness by choosing where the velocity is  $0.99V_\infty$
- At  $y = 0$  (plate surface),  $V = 0$ . The heat transfer there is thus by conduction only so that Fourier's law applies
- Here  $\dot{q}_{cond} = -k_{fluid} \frac{\partial T}{\partial y}|_{y=0}$ . We have also defined  $\dot{q}_{conv} = h(T_s - T_\infty)$

- At  $y = 0$ ,  $\dot{q}_{conv} = \dot{q}_{cond}$  so that  $h = \frac{-k_{fluid} \frac{\partial T}{\partial y}|_{y=0}}{T_s - T_\infty}$
- Therefore  $h$  depends on  $k_{fluid}$  and the temperature gradient  $\frac{\partial T}{\partial y}|_{y=0}$ . This leads to thermal boundary layers
- Thermal Boundary layer
  - Temperature of the surface is  $T_s > T_\infty$
  - Fluid coming at temperature  $T_\infty$
  - When the fluid comes in contact with the plate, there cannot be a discontinuity so it must be equal to  $T_s$  at the contact point
  - INSERT PIC FROM NOTES. We define the thermal boundary layer in a similar way to be the point where  $T - T_s = 0.99(T_\infty - T_s)$
  - $\frac{\partial T}{\partial y}|_{y=0}$  is the temperature gradient.
  - $h$  changes with position as the local  $\frac{\partial T}{\partial y}|_{y=0}$  changes
  - We define a local heat transfer coefficient  $h(x)$
  - We can average:  $\bar{h} = \frac{1}{L} \int_0^L h(x) dx$
  - Instead of worrying about local variations, we use the average value of  $h$
- Velocity Boundary layer flow
  - The difference between the boundary and the surfaces increases linearly as a straight path in laminar flow
  - There is a transition region then where the path will start becoming unstable which eventually becomes a turbulent region with turbulent flow
  - Fluid exerts a drag on the plate. Measured in terms of the shear stress (force per unit area)
  - $\tau = \mu \frac{\partial V}{\partial y}|_{y=0}$  where  $\mu$  is the fluid viscosity ( $\frac{kg}{ms}$ )
  - Velocity gradient can be solved but it is very complicated and practically we define a friction coefficient
  - We imagine a fluid coming to rest at a stagnation point. Using Bernoulli's equation,  $\frac{P}{\rho} = \frac{V_\infty^2}{2} + \frac{P_\infty}{\rho} \implies P - P_\infty = \frac{\rho V_\infty^2}{2}$ . This is the pressure rise and the force felt by plate
  - We define the friction coefficient  $c_f$  so that  $\tau = c_f \frac{\rho v_\infty^2}{2}$
  - Generally we expect  $c_f \sim 1$  but this depends on the shape
- Laminar & Turbulent Flow
  - Heat transfer is greater in turbulent flow i.e. with an increased velocity
  - However when the heat transfer goes up, shear goes up and so bigger fans (more energy) are needed

- The transition to turbulence depends on the ratio of fluid inertia to viscosity
- A high inertia drives random motion and therefore turbulence
- A high viscosity damps turbulence
- Consider a mass with diameter  $D$  and a fluid coming in around it at velocity  $V_\infty$ 
  - \* There is an inertial force  $F_i$  and a viscous force  $F_v$
  - \* Take the characteristic distance to be  $D$
  - \* The inertial force  $F_i = ma$  where the mass  $m = \rho D^3$  and the acceleration  $a = \frac{V_\infty^2}{D}$
  - \* The viscous force  $F_v = \tau A = \mu \frac{\partial V}{\partial y} \cdot A$
  - \*  $F_v \sim \mu \frac{V_\infty}{D} \cdot D^2 \implies \frac{F_i}{F_v} = \frac{\rho V_\infty D}{\mu}$
  - \* This number is known as the Reynolds number:  $Re = \frac{\rho V_\infty D}{\mu}$

## 14 Forced Convection Currents

- Fluid with velocity  $V_\infty$  and density  $\rho_{mu}$ . What forces are exerted onto the body (with characteristic length being the diameter  $D$ )
  - Inertial force  $F_i = ma$ 
    - \*  $m \sim \rho D^3$
    - \* The fluid starts with velocity  $V_\infty$  and is brought to rest over a distance  $D$
    - \*  $t = \frac{D}{V_\infty}$
    - \*  $\Delta V = V_\infty$  so  $a \sim \frac{\Delta v}{t} = \frac{V_\infty}{\frac{D}{V_\infty}} = \frac{V_\infty^2}{D}$
    - \* Thus  $F_i \sim \rho D^3 (\frac{V_\infty^2}{D}) = \rho D^2 V_\infty^2$
  - Viscous Force
    - \*  $F_v = \tau A = \mu \frac{dV}{dy} \cdot A$
    - \*  $F_v \sim \mu \frac{V_\infty}{D} \cdot D^2$
  - We are interested in the ratio
    - \*  $\frac{F_i}{F_v} \sim \frac{\rho V_\infty D}{\mu}$
    - \* This is a very important number called the Reynolds Number  $Re = \frac{\rho V_\infty D}{\mu}$
    - \* The kinematic viscosity is defined as  $\nu = \frac{\mu}{\rho}$  so that the Reynolds number can also be written as  $Re = \frac{V_\infty D}{\nu}$
    - \* For small  $Re$ , viscous forces are dominant. Fluctuations in the flow are damped. This leads to laminar flow.
    - \* For large  $Re$ , inertial forces are dominant. Fluctuations in the flow become amplified and this leads to turbulent flow
    - \* For every geometry, there is a critical value of  $Re$  at which a transition to turbulence occurs e.g.  $Re_{critical, flatplate} = 5 \times 10^5$



- Two boundary layers are developing - velocity, thermal
  - The velocity goes from  $V_\infty$  down to 0 and the temperature goes down from  $T_\infty$  to  $T_s$
  - Let  $\delta_v$  be the velocity boundary layer and  $\delta_t$  be the thermal boundary layer
  - $\delta_t$  may be smaller or larger than  $\delta_v$ . How do we tell?
    - \* This depends on the physical properties of the fluid
  - Fluids with high viscosity  $\nu$  (oils) have thick velocity BL i.e.  $\delta_v$  is a large fraction of  $V_\infty$
  - Fluids with high thermal diffusivity ( $\alpha = \frac{k}{\rho c_p}$ ) have thick thermal BL
  - The ratio  $\frac{\delta_v}{\delta_t}$  is given by the ratio  $\frac{\nu}{\alpha}$
  - The Prandtl Number is defined to be this ratio:  $Pr = \frac{\nu}{\alpha} = \frac{\mu c_p}{k}$
  - $Pr$  is a fluid property
  - For  $Pr \ll 1$  (e.g. a liquid metal)  $\delta_v \ll \delta_t$
  - For  $Pr \gg 1$  (e.g. oils)  $\delta_v \gg \delta_t$
  - For  $Pr \sim 1$  (e.g. gases)  $\delta_t \sim \delta_v$
- We have two dimensionless parameters  $Re = \frac{\rho V_\infty D}{\mu}$  and  $Pr = \frac{\nu}{\alpha}$
- Need to non dimensionalize  $h$ 
  - $\dot{Q}_{conv} = hA(T_s - T_\infty) \sim hD^2(T_s - T_\infty)$
  - Suppose the fluid was not moving
  - Then heat transfer is by conduction only
  - $\dot{Q}_{cond} = k_{fluid}A\frac{dT}{dr} \sim k_{fluid}D^2\frac{T_s - T_\infty}{D}$
  - How much is heat transfer enhanced due to convection
  - This is given by the ratio  $\frac{\dot{Q}_{conv}}{\dot{Q}_{cond}} = \frac{hD}{k_{fluid}}$  which is a dimensionless number
  - This ratio is known as the Nusselt number  $Nu = \frac{hD}{k_{fluid}}$
  - Do not confuse with  $Bi = \frac{hD}{k_{solid}}$
- We started with  $h = f(D, V_\infty, \rho, \mu, c_p, k)$  and dependent on the geometry
- This can now be written as  $\frac{hD}{k} = f\left(\frac{\rho DV_\infty}{\mu}, \frac{\mu c_p}{k}\right)$  and dependent on the geometry
- $\implies Nu = f(Re, Pr)$  and geometry
- Can do experiments
  - Consider a plate with a uniform heat flux due to an electrical current through it
  - Can put it into a wind tunnel with  $V_\infty$  and  $T_\infty$

- We know that  $\dot{Q} = hA(T_s - T_\infty) = P = EI$  (electrical power)
- We know the other variables and can thus solve for  $h$  and plot it as a function of  $V_\infty$
- Repeat for different plate sizes, different  $T_s$  and different  $T_\infty$
- Can plot  $Nu$  vs  $Re$  and all the data should fall on the same curve
- Repeat for different fluids to get different curves for different fluids
- Can then plot  $\ln(\frac{Nu}{Pr^n})$  against  $\ln Re$  and the data for different fluids will all lie on the same line
- $\ln(\frac{Nu}{Pr^n}) = m \ln Re + C$  or equivalently  $Nu = cRe^m Pr^n$  where  $n, m, C$  are determined experimentally for each geometry

## 15 Forced convection correlations

- Read Ch 19.3, 19.4. 19.5 - 19.8 will not be covered
- Dimensionless Analysis
  - Consider a tube with velocity from the bottom
    - \*  $Z$  (height) is in terms of  $P, V$
    - \* What are relevant parameters?
      - $P, V, z$
      - Fluid properties:  $\rho$
      - Gravity  $g$
    - \* Develop an equation relating  $P, V, z, \rho, g$
    - \* If we develop an equation, the dimension of both sides must be equal
    - \*  $P[\frac{N}{m^2}] = \frac{kg \frac{m}{s^2}}{m^2} = [\frac{kg}{ms^2}]$
    - \*  $\frac{P}{\rho}$  is in  $[\frac{m^2}{s^2}] \implies \frac{P}{\rho V^2} [\frac{m^2}{s^2} \times \frac{s^2}{m^2}]$
    - \*  $\frac{g}{V^2}$  is also dimensionless
    - \* Therefore  $\frac{P}{\rho V^2} = f(\frac{gz}{v})$
    - \* We plot  $\frac{P}{\rho V^2}$  against  $\frac{gz}{v^2}$  and we discover that all data falls on one line. If it doesn't fall on one line, the analysis was done incorrectly
    - \* Thus  $\frac{P}{\rho V^2} = -\frac{gz}{v^2} + C_1$  which when simplified gives  $\frac{P}{\rho} + gz + \frac{V^2}{2}$  which is a constant. We can derive Bernoulli's equation experimentally in this way
- Forced Convection Correlation
  - Flow over a flat plate
  - $V_\infty$  flowing from the left, laminar region, then transition and then turbulence
  - $\tau = \mu \frac{\partial V}{\partial y} \sim \mu \frac{V_\infty}{\delta_v}$
  - As  $\delta_v$  goes up,  $\tau$  goes down

- Local frictional coefficient  $c_{f,x}$  goes down initially while in laminar, then goes up while in transition and finally goes down again in turbulence region
- For laminar flow  $c_{f,x} = \frac{0.664}{Re_x^{\frac{1}{2}}}$
- Local Reynolds number  $= Re_x = \frac{V_\infty x}{\nu}$
- Average friction coefficient over length  $L$  of plate:  $c_f = \frac{1}{L} \int_0^L c_{f,x} dx = \frac{1}{L} \int_0^L \frac{0.664}{Re_x^{\frac{1}{2}}} dx = \frac{1}{L} 0.664 \left(\frac{\nu}{V_\infty}\right)^{\frac{1}{2}} \int_0^L \frac{dx}{x^{\frac{1}{2}}} = \frac{2}{L} \times 0.664 \left(\frac{\nu}{V_\infty}\right)^{\frac{1}{2}} \cdot L^{\frac{1}{2}}$
- This gives  $c_f = \frac{1.328}{Re_L^{\frac{1}{2}}}$
- The heat transfer coefficient  $h = -\frac{k}{T_s - T_\infty} \frac{\partial T}{\partial y}|_{y=0}$  so that  $\frac{\partial T}{\partial y} \sim \frac{T_s - T_\infty}{\delta_t}$
- As  $\delta_t$  increases,  $\frac{\partial T}{\partial y}$  goes down implying that  $h$  decreases
- So  $h$  decreases while in laminar flow, increases in the transition and then decreases again in turbulent region
- We define a Local Nusselt Number:  $Nu_x = \frac{h_x x}{k}$
- For laminar flow,  $Nu_x = 0.332 Re_x^{\frac{1}{2}} Pr^{\frac{1}{3}}$  where  $Pr \geq 0.6$
- The average Nusselt number is  $Nu = \frac{hL}{k} = \frac{1}{L} \int_0^L Nu_x dx$
- This gives  $Nu = 0.664 Re_L^{\frac{1}{2}} Pr^{\frac{1}{3}}$
- For turbulent flow,  $Re_x > 5 \times 10^5$  and  $c_{f,x} = \frac{0.0592}{Re_x^{\frac{1}{4}}}$

• Example

- Air with  $T_\infty = 300C$ ,  $V_\infty = 10$  on a tube with  $T_s = 50$  and  $L = 0.5$ . Find  $\dot{Q}_{cooling}$
- The film temperature is used where  $T_f = \frac{T_\infty + T_s}{2}$
- In this case,  $T_f = 175$  and using  $\nu = 3.18 \times 10^{-5}$ ,  $Pr = 0.7$  and  $k = 0.0363$  (using tables)
- Therefore  $Re_L = \frac{V_\infty L}{\nu} = 1.57 \times 10^5$
- Flow is laminar since  $Re_L < 5 \times 10^5$
- $Nu = 0.664 Re_L^{\frac{1}{2}} Pr^{\frac{1}{3}} = 233.6$
- $Nu = \frac{hL}{k} \implies h = \frac{Nu k}{L} = 16.9 \frac{W}{m^2 C}$
- Cooling per unit width of the plate  $\dot{Q} = hA(T_\infty - T_s) = 16.9 \times (0.5 \times 1)(300 - 50) = 2112.5 \frac{W}{m}$

• Flows over cylinders and spheres

- Flow separation causes wake
- Not to be confused with turbulence
- Turbulence occurs when  $Re = \frac{V_\infty D}{\nu} > 2 \times 10^5$

- For flow across cylinders,  $Nu = cRe^m Pr^n$
- The values of  $c, m, n$  depend on the range of the Reynolds number - given in Table 19.2
- Churchill & Bernstein correlation is valid for  $RePr > 0.2$
- Fluid properties evaluated at  $T_f = \frac{T_s + T_\infty}{2}$
- Flow over a sphere has  $Nu = 2 + [0.4Re^{\frac{1}{2}} + 0.06Re^{\frac{2}{3}}] \cdot Pr^{0.4} \left( \frac{\mu_\infty}{\mu_s} \right)^{0.25}$
- All properties evaluated at  $T_\infty$  and  $\mu_s$  is evaluated at  $T_s$
- Valid for  $3.5 \leq Re \leq 80000$  and  $0.7 \leq Pr \leq 380$

## 16 Thermal Radiation, Black body radiation, Radiative properties

- Read Ch 21.1 - 21.4
- Radiation
  - Consider a solid at temperature  $T_s$  with an enclosure outside at  $T_{surr}$  and a vacuum in between
  - Initially  $T_s > T_{surr}$
  - No conduction, convection since vacuum so heat transfer is by radiation
  - Solid will lose heat to surrounding surface and cool until  $T_s = T_{surr}$
  - Thermal radiation: Energy is emitted by matter as a result of its finite temperature
  - Energy is in the form of electromagnetic waves
  - Radiation has wave properties: frequency  $\nu$  and wavelength  $\lambda$  related by  $\lambda = \frac{c}{\nu}$
  - Thermal radiation has a wavelength from 0.1 to 100  $\mu m$ . This includes ultraviolet (0.1 – 0.4  $\mu m$ ), visible light (0.4 – 0.7  $\mu m$ ) and infrared (0.7 – 100  $\mu m$ )
  - For opaque objects, radiation occurs from the surface
- Black body radiation
  - A black body is a perfect emitter of radiation
  - At a given temperature, no surface can emit more energy than a Blackbody
  - A blackbody absorbs all radiation incident on
  - It emits equally in all directions. It is a "diffuse" surface
  - The Stefan-Boltzmann law: The radiation energy emitted by a blackbody per unit time and per unit surface area is:  $E_b = \sigma T^4$  (in  $\frac{W}{m^2}$ ) where  $\sigma = 5.67 \times 10^{-8}$ ,  $E_b$  is the blackbody emissive power and  $T$  is the temperature in  $K$

- A surface painted black is close to a blackbody for visible radiation
- A white surface absorbs infrared light - can be considered a blackbody in IR
- Depending on the wavelength, different objects can be considered blackbodies
- To get a perfect blackbody, you take a box with a small opening and the opening is the blackbody
- This is because the aperture absorbs all light (anything that goes inside the opening reflects inside there and is thus absorbed)
- Radiation from a real surface encompasses a range of wavelengths. This is described by a "spectral distribution"
- Can plot Emission energy  $E_{b,\lambda}$  against  $\lambda$  to obtain a curve described by Planck's Law:  $E_{b,\lambda} = \frac{c_1}{\lambda^5 [\exp(\frac{c_2}{\lambda T}) - 1]}$
- There may also be a directional distribution
- Surface emits more in a given direction
- Radiation properties
  - For a real surface, the emissive power is less than that of a blackbody
  - We define a surface property - emissivity
  - $\varepsilon(T) = \frac{E(t)}{E_b(t)}$  where  $E(t)$  is integrated over all  $\lambda$  and  $\theta$  and  $E_b(t)$  is integrated over all  $\lambda$
  - We will assume that  $\varepsilon$  is independent of  $\lambda$ . This is known as a gray surface
  - $\varepsilon$  is independent of  $\theta$ : A diffuse surface
  - The emissive power of a real surface is  $E(t) = \varepsilon \sigma T^4$
- Surface Absorption, Reflection and Transmission
  - $G$  is the incident radiation in  $\frac{W}{m^2}$
  - Part of it will be reflected ( $G_{ref}$ ), part will be absorbed  $G_{abs}$  and the rest will be transmitted ( $G_{transmitted}$ )
  - $G$ -radiation is the radiant energy incident on a surface per unit surface area per unit time
  - Define 3 properties: Absorptivity  $\alpha = \frac{G_{abs}}{G}$ , the reflectivity  $\rho = \frac{G_{ref}}{G}$  and the transmittivity  $\tau = \frac{G_{tr}}{G}$
  - In general  $\alpha + \rho + \tau = 1$
  - For opaque objects,  $\tau = 0$ , for a blackbody  $\alpha = 1$
  - The "Gray Body assumption" is that  $\alpha, \rho, \tau$  are independent of  $\lambda$
  - The "Diffuse surface assumption" is that  $\alpha, \rho, \tau$  do not depend on direction

## 17 Radiation heat transfer - black surfaces

- Consider a small body inside an enclosure
  - Let the small body have surface area  $A$ , emissivity  $\epsilon$  and absorptivity  $\alpha$
  - The temperature inside the enclosure is  $T$  and at equilibrium both the surface and the inside are at the same temperature
  - $G$  is the incident radiation per unit area
  - The large cavity acts as a black body
  - We neglect absorption by the small body
  - The cavity surfaces absorb all incident radiation
  - We can assume that  $G = \sigma T^4$
  - For a small body  $E_{abs} = \alpha GA = \alpha \sigma T^4 A$  is the energy absorbed
  - $E_{emit} = \epsilon \sigma T^4 A$
  - At equilibrium,  $E_{abs} = E_{emit}$  so that  $\sigma = \epsilon$
  - This is Kirchoff's law which says that for any surface the emissivity is equal to the absorptivity
- Radiation between surfaces
  - Two surfaces which are exchanging energy due to radiation
  - Amount of radiation incident on a surface depends on the orientation of the surfaces
- The View Factor
  - Consider two surfaces  $i$  and  $j$
  - We define the view factor  $F_{ij}$  as the fraction of radiation leaving surface  $i$  that reaches surface  $j$  directly
  - e.g.  $F_{1,3}$  is the fraction of energy leaving surface 1 which reaches surface 3 directly
  - Can also define  $F_{ii}$  for a concave surface which would be the fraction leaving it that reaches it on the other end
  - If the surface is convex,  $F_{ii} = 0$
  - If one surface  $i$  is completely enclosed by another surface  $j$ ,  $F_{ii} = 0$  and  $F_{ij} = 1$
- Calculation of view factors
  - Done by integrating geometric shapes
  - Can calculate the energy exchanges  $dA_1$  and  $dA_2$
  - For common geometries, the view factor calculations can be done based on charts and tables

- Table 21.3, 21.4, Fig 21.33 can be used
- In general, for an enclosure with  $N$  sides,  $\sum_{i=1}^N NF_{ij} = 1$
- All radiation leaving surface  $i$  must be intercepted by other surfaces
- For an enclosure of  $N$  surfaces, a total of  $N^2$  view factors
- These can be put into a matrix
- Not all view factors are independent. The summation rule says that  $\sum_{j=1}^N F_{i,j} = 1$
- The reciprocity rule
  - \* If  $A_1, A_2$  are blackbodies then all incident radiation is absorbed so that  $\alpha = \epsilon = 1$
  - \* Then the energy leaving  $A_1$  and reaching  $A_2$  is  $E_{b1}A_1F_{12}$
  - \* Doing the same in the reverse direction, the energy leaving  $A_2$  and reaching  $A_1$  is  $E_{b2}A_2F_{21}$
  - \* The net energy exchange  $Q_{12}$  is  $Q_{12} = E_{b1}A_1F_{12} - E_{b2}A_2F_{21}$
  - \* If both bodies are at the same temperature, there is thermal equilibrium so  $Q_{12} = 0$
  - \* Moreover  $E_{b1} = E_{b2} = \sigma T^4$
  - \* Thus  $A_1F_{12} = A_2F_{21}$
  - \*  $A_1, A_2, F_{12}, F_{21}$  are all geometric properties independent of  $T, \epsilon$
  - \* Thus in general for any two surface  $i, j$ ,  $A_iF_{ij} = A_jF_{ji}$
- Superposition
  - \* Suppose you break up surface  $j$  in two parts  $a$  and  $b$
  - \* Then  $F_{ij} = F_{i,ja} + F_{i,jb}$
- Symmetry
  - \* Consider a geometry such that surface  $j$  and  $k$  are identical
  - \* Then  $F_{ij} = F_{ik}$  and  $F_{ji} = F_{ki}$
- Example: Long duct of length  $L$ 
  - A 3/4 circle with radius  $R$  with area  $A_2$  and the slice with area  $A_1$
  - $F_{12} = 1$ . Note  $F_{21} \neq 1$  since 2 is concave and not all of the radiation goes from there to  $A_1$
  - $A_2F_{21} = A_1F_{12} \implies F_{21} = \frac{A_1}{A_2}F_{12}$
  - $\implies F_{21} = \frac{\frac{3}{4}2\pi RL}{\frac{3}{4}(2\pi R)L} = \frac{4}{3\pi} \approx 0.424$
  - $F_{22} + F_{21} = 1 \implies F_{22} = 1 - F_{21} = 0.576$
- Example: Small sphere under a concentric hemisphere
  - $A_1$  is the area of the small sphere and  $A_2$  is that of the hemisphere so that  $A_2 = 2A_1$

- We can extend the hemisphere to a sphere and let  $A_3$  be the area of the added region (ADD DIAGRAM)
- We know that  $F_{11} + F_{12} + F_{13} = 1$  where  $F_{11} = 0$  since it is a convex surface
- By symmetric,  $F_{12} = F_{13} \implies F_{12} = 0.5$
- By reciprocity,  $F_{21} = \frac{A_1}{A_2} F_{12} = \frac{A_1}{2A_1} 0.5$  so  $F_{21} = 0.25$
- Radiation from black surfaces
  - Black surface means no reflection
  - All incident radiation is absorbed
  - Two surface  $A_1$  and  $A_2$  with temperatures  $T_1$  and  $T_2$  respectively
  - Energy from  $A_1 \rightarrow A_2 = A_1 E_{b1} F_{12}$
  - Energy from  $A_2 \rightarrow A_1 = A_2 E_{b2} F_{21}$
  - Net radiation exchange  $\dot{Q}_{12} = A_1 E_{b1} F_{12} - A_2 E_{b2} F_{21}$
  - Since  $A_1 F_{12} = A_2 F_{21}$ ,  $\dot{Q}_{12} = A_1 F_{12} (E_{b1} - E_{b2})$
  - $\implies \dot{Q}_{12} = A_1 F_{12} \sigma (T_1^4 - T_2^4)$
  - Since  $F_{12} = 1$ ,  $\dot{Q}_{12} = A_1 \sigma (T_1^4 - T_2^4)$